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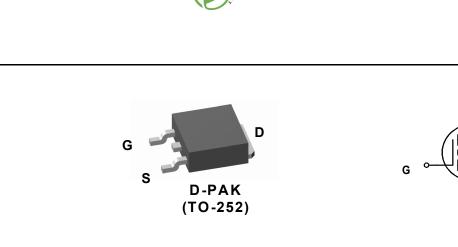


# **ON Semiconductor**®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="https://www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="https://www.onsemi.com">Fairchild\_questions@onsemi.com</a>.

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N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

**General Description** 

switching performance.

DC - DC Conversion

Application

This N-Channel MOSFET is produced using Fairchild

Semiconductor's advanced PowerTrench<sup>®</sup> process that

incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior

D

## **MOSFET Maximum Ratings** T<sub>C</sub> = 25 °C unless otherwise noted.

Symbol	Param	eter		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			150	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 5)	51		
	-Continuous	T <sub>C</sub> = 100 °C	(Note 5)	27		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	8	Α	
	-Pulsed		(Note 4)	164		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	180	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		132	w	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	3.1	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

FAIRCHILD

FDD86250

**Features** 

■ 100% UIL tested

RoHS Compliant

**150 V, 51 A, 22 m**Ω

Shielded Gate MOSFET Technology

• Max  $r_{DS(on)}$  = 22 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 8 A

Max r<sub>DS(on)</sub> = 31 mΩ at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 6.5 A

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case		0.94	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	C/W

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86250	FDD86250	D-PAK(TO-252)	13 "	16 mm	2500 units

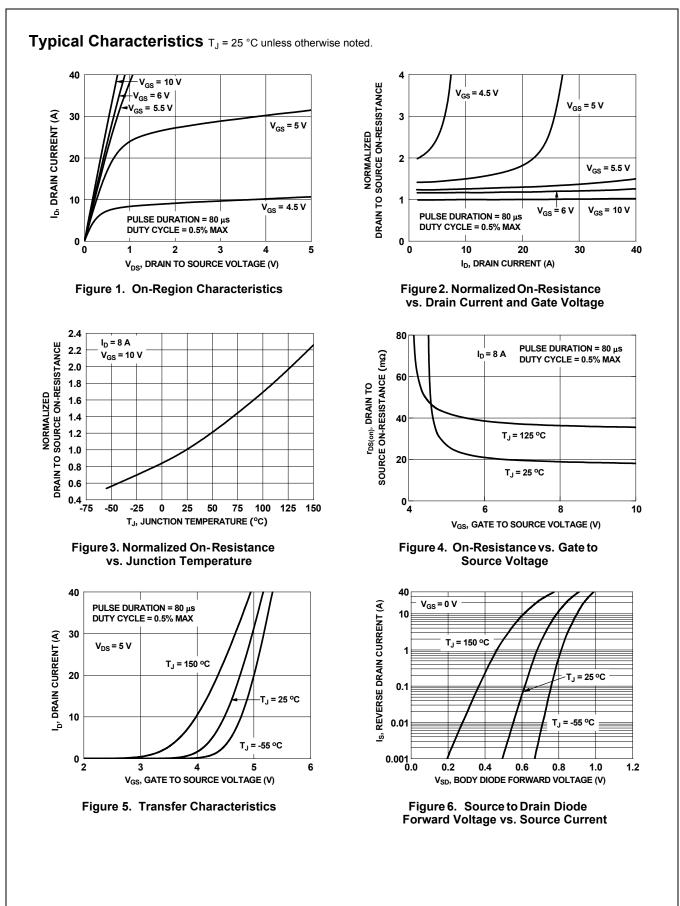


	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Chara	acteristics						
3V <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	150	1		V	
ABV <sub>DSS</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		106		mV/°C	
$\Delta T_{J}$	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μA	
DSS	-	$V_{\rm DS} = 120$ V, $V_{\rm GS} = 0$ V $V_{\rm GS} = \pm 20$ V, $V_{\rm DS} = 0$ V			±100	nA	
GSS	Gate to Source Leakage Current	v <sub>GS</sub> - ±20 v, v <sub>DS</sub> - 0 v			100	IIA	
	icteristics			n.	I.	1	
/ <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2.0	2.9	4.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250 µA, referenced to 25 °C		-10		mV/°C	
r <sub>DS(on)</sub>	· · ·	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A		18.4	22		
	Static Drain to Source On Resistance	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 6.5 A		21.4	31		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A, T <sub>J</sub> = 125 °C		35.8	45	-	
FS	Forward Transconductance	$V_{\rm DS} = 10 \text{ V}, \text{ I}_{\rm D} = 8 \text{ A}$		28		S	
)ynamic	Characteristics						
Piss	Input Capacitance			1585	2110	pF	
Poss	Output Capacitance	$V_{DS} = 75 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		167	225	pF	
2rss	Reverse Transfer Capacitance	f = 1 MHz		7	15	pF	
Rg	Gate Resistance			0.6		Ω	
d(on)	Turn-On Delay Time Rise Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 8 A,		11.2 3.7	20 10	ns ns	
r d(off)	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		20	32	ns	
f	Fall Time			4	10	ns	
, ζ <sup>d</sup>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		23	33	nC	
_g 2 <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V$ ,		12.8	18	nC	
-y 2 <sub>gs</sub>	Gate to Source Charge	$I_D = 8 A$		6.7		nC	
∠ <sub>gd</sub>	Gate to Drain "Miller" Charge			4.7		nC	
	-						
Jrain-Sol	urce Diode Characteristics	$V_{\rm c} = 0 V_{\rm c} = 0 A_{\rm c}$ (Note 2)		0.70	1.0	V	
/ <sub>SD</sub>	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 8 A$ (Note 2) $V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.78	1.3 1.2	v	
		$V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.73	1.2		
rr C	Reverse Recovery Time	I <sub>F</sub> = 8 A, di/dt = 100 A/μs		71		ns	
ל <sup>ער</sup>	Reverse Recovery Charge			104	166	nC	

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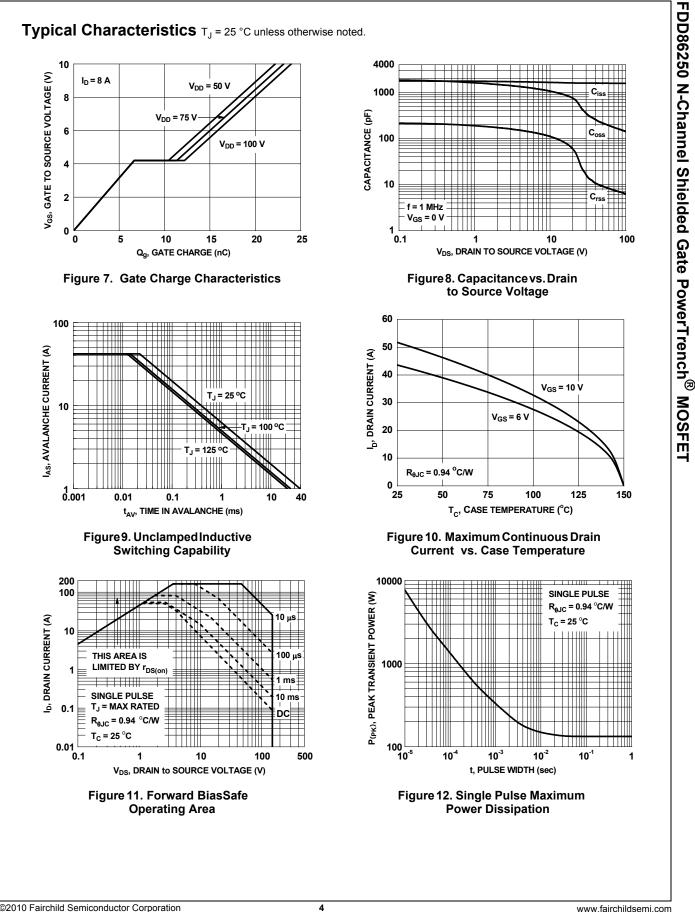
Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.</li>
Starting T<sub>J</sub> = 25 °C, L = 1.0 mH, I<sub>AS</sub> = 19 A, V<sub>DD</sub> = 135 V, V<sub>GS</sub> = 10 V.
Pulsed Id please refer to Fig 11 SOA graph for more details.
Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

FDD86250 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

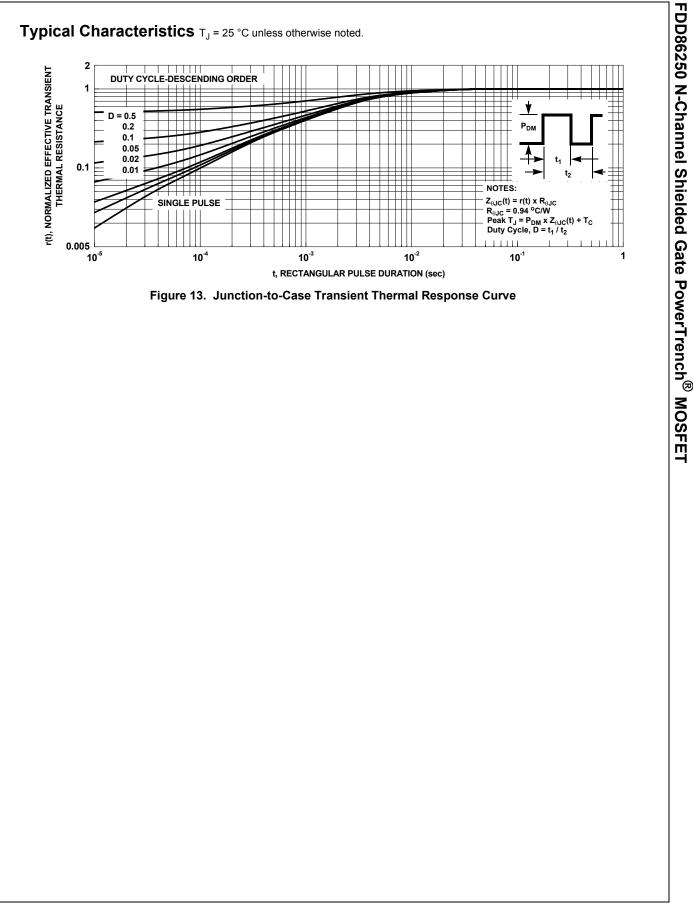


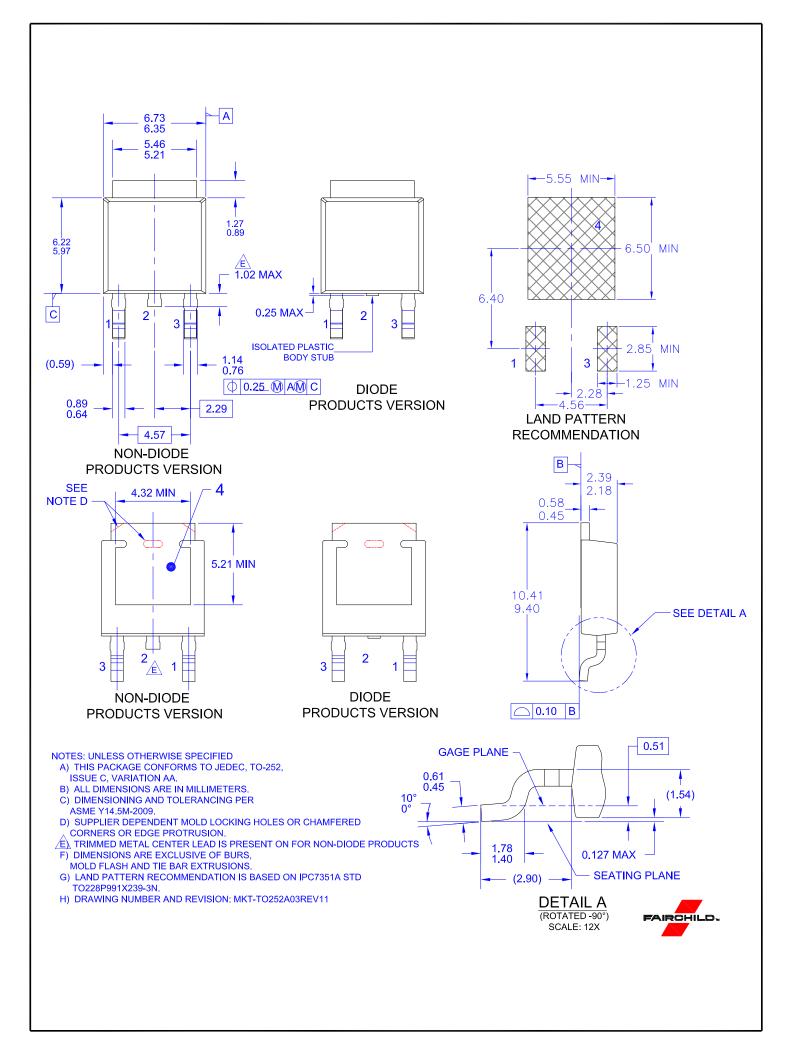
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